ISOLA LAMINATE SYSTEMS

Product and Solutions Offering

Isola Laminate Systems' broad range of laminate, prepreg and foil products and solutions includes:

• PWB Substrates

FR-4s

Composites

Advanced PWB

Substrates

BT/Epoxy Polyimide

P97 & P27

Specialty Prepregs

- HDI Materials
- Signal Integrity Substrates
- Buried Passive Solutions
- Packaging Substrates

P97 & P27

Polyimide Laminate and Prepreg

Isola Laminate Systems offers a product line of polyimide-based prepreg and copper clad laminates for high temperature printed circuit applications. These products consist of a flame resistant polyimide resin system suitable for military, commercial or industrial electronic applications requiring superior performance and the utmost in thermal properties. They utilize a polyimide and thermoplastic blend of resin, fully cured without the use of MDA (Methylene Dianiline). This results in a polymer with a high Tg without the characteristic difficulties of brittleness and low initial bond strength associated with traditional thermoset polyimides.

Performance and Processing Advantages

High Tg - 260°C TMA

Greater thermal performance over epoxy-bismaleimide blends

Maintains Bond Strength at High Temperature

• Tough Resin System

Improved processing due to less brittleness Less delamination from machining

- Flammability Rating V-0
- Non-MDA (Methylene Dianiline) Chemistry

Meets all OSHA 1910.1050 requirements

Purchasing Information

Industry Approvals

IPC 4101/40/41/42

UL Recognized - GPY, UL File Number E41625

Standard Availability

Overall Thicknesses: 0.0025" to 0.125"

Available in sheet or panel form

Copper Foil Cladding: 1/2, 1, & 2 oz.

Options - Double-Treat, HTE, Copper-Invar-Copper

Prepregs: Available in roll or panel form Glass Styles - 106, 1080, 2313, 2116, 7628



Ordering Information

Contact your local sales representative or the Inside Sales Department in La Crosse, WI.

Phone: 1-800-845-2904 or 608-784-6070 Fax: 1-800-344-1825 or 608-791-2428

Isola Laminate Systems Corp. 230 North Front Street La Crosse, WI 54601

For further information visit www.isolalaminatesystems.com

P97 Typical Laminate Properties, 0.008" [0.20mm]

PROPERTY Thickness	<u>UNITS</u> inches mm	IPC 4101 <0.030 [<0.78]	P97 VALUE 0.008 [0.20]	CONDITIONING —
Construction			2313/2116	_
Retained Resin	%		47	_
	,-			
Thermal				
Tg, min - (TMA)	°C	250	260*	E-2/105
CTE - x-axis	ppm/°C	_	17	Ambient to Tg
y-axis	ppm/°C		14	Ambient to Tg
z-axis	ppm/°C		54	Ambient to 288°C
Thermal Stress, 288°C	seconds	10	>900	E-2/105
Electrical				
Permittivity (Dk), max. @		F 4	4.4	C 40/22/50
I MHz (2 Fluid Cell)		5.4	4.4	C-40/23/50
500 MHz (HP 4291)		_	4.2	C-40/23/50
I GHz (HP4291)	_	_	4.2	C-40/23/50
Loss Tangent (DF), max. @		0.035	0.014	C 40/22/50
I MHz (2 Fluid Cell)	_	0.035	0.014	C-40/23/50
500 MHz (HP 4291)		_	0.012	C-40/23/50
I GHz (HP4291)			0.014	C-40/23/50
Surface Resistivity, min.	megohms	lx10⁴	5.0×10 ⁵	C-96/35/90
VI British	megohms	6x10⁴	1.6×10 ⁸	E-24/204
Volume Resistivity, min.	megohm-cm	lx10⁴	3.4×10 ⁸	C-96/35/90
	megohm-cm	6x10⁴	1.3×10 ⁸	E-24/204
Electric Strength, min.	volts/mil	737	1340	D-48/50
	[volts/mm]	[2.90×10 ⁴]	[5.3×10⁴]	— D. 40/50
Arc Resistance, min.	seconds	120	130	D-48/50
Physical Physical				
Peel Strength, min 1 oz.	lb/in		9.1	Condition A
reer strength, min 1 oz.	[Kg/M]		[162]	Condition A
	lb/in	3.9	8.6	After Thermal Stress
	[Kg/M]	[70]	[152]	After Thermal Stress
	lb/in	3.35	7.2	E-1/170
	[Kg/M]	[60]	[130]	E-1/170
Flammability	נייציי ין	[٥٥]		
			V_0	I II 94
Moisture Absorption, max.	<u> </u>	 1.0	V-0 .54 *	UL94 D-24/23

^{*} Material Thicknes Tested 0.028

[&]quot;The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold."